

- CASE

5th Generation CoolSiC[™] 1200V Schottky Diode

SiC Diode

Features

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / no forward recovery
- Temperature independent switching behaviour
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Pb-free lead plating; RoHS compliant





Pin 1 and backside: Cathode Pin 2: Anode

Potential applications

- Drives
- Industrial power supplies: Industrial UPS
- Solar central inverters and Solar string inverter

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC 47/20/22

Description

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size/cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- Related Links: www.infineon.com/SiC









Key performance parameters

Туре	V _{DC}	I _F	Q_{c}	$T_{vj,max}$	Marking	Package
IDK20G120C5	1200 V	20 A	82nC	175°C	D2012C5	PG-T0263-2



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SiC Diode



Maximum ratings

Maximum ratings 1

Note:

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit	
Repetitive peak reverse voltage	V_{RRM}	1200	V	
<i>T</i> _C ≥ 25°C	* KKW	1200	, ,	
Continuous forward current for R _{th(j-c,max)}				
$T_{\rm C} = 145^{\circ}{\rm C}, {\rm D}=1$	l _F	20	А	
$T_c = 135^{\circ}C, D=1$	TF.	27	A	
$T_{\rm C} = 25^{\circ}{\rm C}, {\rm D}{=}1$		56		
Surge repetitive forward current, sine halfwave ¹				
T_{C} =25°C, t_{p} =10ms	$I_{F,RM}$	80	А	
$T_c=100$ °C, $t_p=10$ ms		60		
Surge non-repetitive forward current, sine halfwave				
$T_{\rm C}$ =25°C, $t_{\rm p}$ =10ms	$I_{F,SM}$	198	Α	
$T_c=150$ °C, $t_p=10$ ms		168		
Non-repetitive peak forward current		1200	۸	
$T_{\rm C} = 25^{\circ}{\rm C}, t_{\rm p} = 10 \ \mu{\rm s}$	$I_{F,max}$	1200	A	
i²t value				
$T_{\rm C} = 25^{\circ}{\rm C}, t_{\rm p} = 10 {\rm ms}$	∫i²dt	195	A^2s	
$T_{\rm C} = 150$ °C, $t_{\rm p} = 10$ ms		140		
Diode dv/dt ruggedness	d. //d4	150	VII	
V _R =0960 V	dv/dt	150	V/ns	
Power dissipation for R _{th(j-c,max)}		222		
T _C = 25°C	P_{tot}	330	W	

¹ Not subject to production test. The test was performed with 20000 pulses (two consecutive half-wave rectified sines with 10 ms period).

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Maximum ratings

Operating temperature	$T_{ m vj}$	-55175	°C
Storage temperature	T_{stg}	-55150	°C
Soldering temperature, reflow soldering (MSL1 according to JEDEC J-STD-020)	T_{sold}	260	°C

SiC Diode



Thermal resistances

Thermal resistances 2

Davamatav	Symbol	Conditions	Value			
Parameter			min.	typ.	max.	Unit
Characteristic						
Diode thermal resistance, junction – case	$R_{th(j-c)}$		-	0.35	0.46	K/W
Thermal resistance, junction – ambient	$R_{th(j-a)}$	Leaded	-	-	62	K/W

Electrical Characteristics



3 Electrical Characteristics

Static Characteristics, at $T_{\nu j}$ =25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
Parameter	Symbol	Conditions	min.	typ.	max.	Oilit
DC blocking voltage	V _{DC}	$T_{\rm vj} = 25^{\circ}\text{C}, I_{\rm R} = 50 \mu\text{A}$	1200	-	-	V
Diode forward voltage	1/	I _F = 20A, T _{vj} =25°C	-	1.5	1.8	V
	V_{F}	I _F = 20A, T _{vj} =150°C	-	2.0	-	
Reverse current	,	V _R =1200V, T _{vj} =25°C	-	8.5	123	μА
	I _R	V_{R} =1200V, T_{vj} =150°C	-	44	-	

Dynamic Characteristics, at $T_{\nu j}$ =25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
raiailletei			min.	typ.	max.	Oilit
Total capacitive charge		$V_R = 800V, T_{vj} = 150$ °C				
	Qc	$Q_C = \int_0^{V_R} C(V) dV$	-	82	-	nC
		<i>V</i> _R =1 V, <i>f</i> =1 MHz	-	1050	-	
Total Capacitance	С	V _R =400 V, <i>f</i> =1 MHz	-	74	-	pF
		V _R =800 V, <i>f</i> =1 MHz	-	59	-	

Electrical Characteristics Diagrams



4 Electrical Characteristics Diagrams

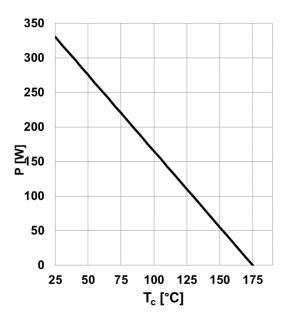


Figure 1. Power dissipation as function of case temperature, $P_{tot}=f(T_c)$, $R_{th(j-c),max}$

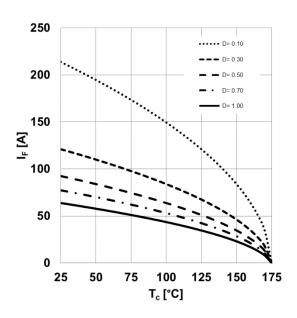


Figure 2. Diode forward current as function of temperature, parameter: $T_{vj} \le 175^{\circ}\text{C}$, $R_{th(j-c),max}$, D = duty cycle, V_{th} , R_{diff} @ $T_{vj} = 175^{\circ}\text{C}$

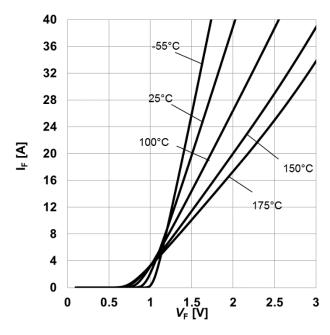


Figure 3. Typical forward characteristics, $I_F = f(V_F)$, $t_p = 10 \mu s$, parameter: T_{vj}

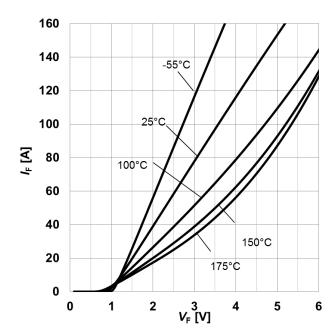
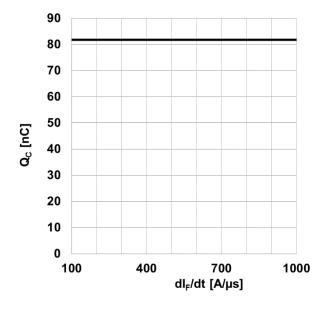


Figure 4. Typical forward characteristics in surge current, $I_F = f(V_F)$, $t_p = 10 \mu s$, parameter: T_{vj}

SiC Diode

Electrical Characteristics Diagrams





1E-4

1E-5

1E-6

1E-7

1E-7

1E-8

25°C

-55°C

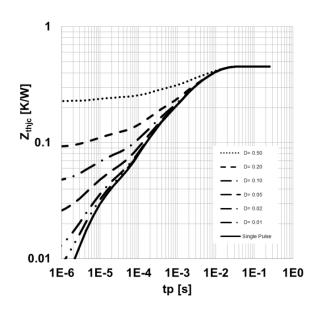
1E-9

200 400 600 800 1000 1200

V_R [V]

Figure 5. Typical capacitive charge as function of current slope, $Q_c=f(dIF/dt)$, $T_{vj}=150$ °C

Figure 6. Typical reverse characteristics, I_R =f(V_R), parameter: T_{vj}



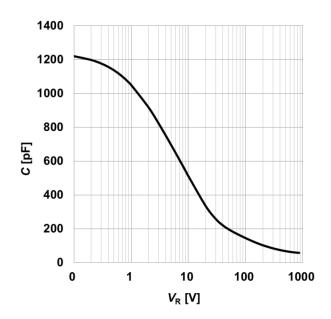


Figure 7. Max. transient thermal impedance, $Z_{th,j-c}=f(t_P)$, parameter: $D=t_P/T$

Figure 8. Typical capacitance as function of reverse voltage, $C=f(V_R)$; $T_{vi}=25^{\circ}C$; f=1 MHz

SiC Diode

Electrical Characteristics Diagrams



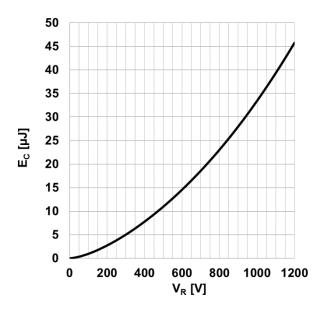


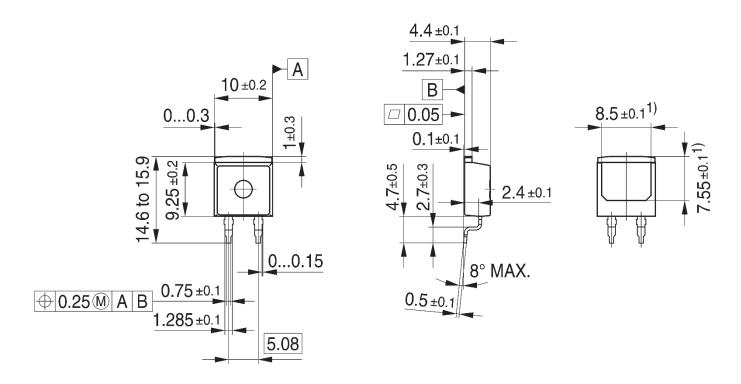
Figure 9. Typical capacitively stored energy as function of reverse voltage, $E_c=f(V_R)$

Package Drawing



5 Package Drawing

PG-TO263-2



Typical
 Metal surface min. X = 7.25, y = 6.9
 All metal surfaces: tin plated, except area of cut

2021-07-14

SiC-Diode

Revision history



Revision history

Document version	Date of release	Description of changes
V 2.0	2019-10-28	Final Datasheet
V 2.1	2021-07-14	Increased dv/dt ruggedness

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Document reference

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